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### **TLE7276**

Low Drop Linear Voltage Regulator 5V Fixed Output Voltage

### **Data Sheet**

Rev. 1.11, 2010-11-22

# Automotive Power

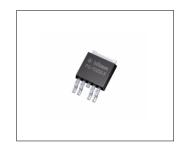


#### 5-V Low Drop Voltage Regulator

**TLE 7276** 

#### **Features**

- Output voltage 5 V ±2%
- Ultra low current consumption: typ. 20 μA
- 300 mA current capability
- · Inhibit input
- Very low-drop voltage
- · Short-circuit-proof
- Suitable for use in automotive electronics



#### **Functional Description**

The TLE 7276 is a monolithic integrated low-drop voltage regulator for load currents up to 300 mA. An input voltage up to 42 V is regulated to  $V_{\rm Q,nom}$  = 5.0 V with a precision of  $\pm 2\%$ . The sophisticated design allows to achieve stable operation even with ceramic output capacitors down to 470 nF. The device is designed for the harsh environment of automotive applications. Therefore it is protected against overload, short circuit and overtemperature conditions. Of course the



TLE 7276 can be used also in all other applications, where a stabilized 5 V voltage is required. Due to its ultra low stand-by current consumption of typ. 20  $\mu$ A the TLE 7276 is dedicated for use in applications permanently connected to  $V_{\rm BAT}$ . The regulator can be shut down via an Inhibit input. An integrated output sink current circuitry keeps the voltage at the Output pin Q below 5.5 V even when reverse currents are applied. Thus connected devices are protected from overvoltage damage.

For applications requiring extremely low noise levels the Infineon voltage regulator family TLE 42XY and TLE 44XY is more suited than the TLE 7276. A mV-range output noise on the TLE 7276 caused by the charge pump operation is unavoidable due to the ultra low quiescent current concept.

Туре	Ordering Code	Package
TLE 7276 D	Q67006-A9733	P-TO252-5-1,P-TO252-5-11
TLE 7276 G	Q67006-A9732	P-TO263-5-1



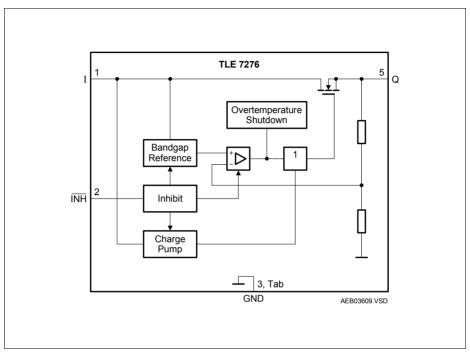


Figure 1 Block Diagram



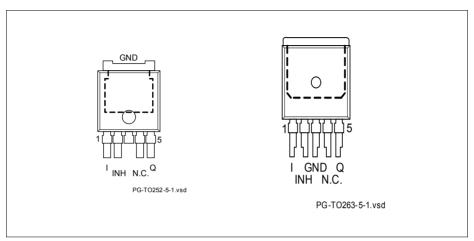


Figure 2 Pin Configuration P-TO252-5 (D-PAK), P-TO263-5 (D<sup>2</sup>-PAK)(top view)

Table 1 Pin Definitions and Functions

Pin No.	Symbol	Function
1	I	Input; block to ground directly at the IC with a ceramic capacitor
2	ĪNH	Inhibit Input; low level disables the IC. Integrated pull-down resistor
3	GND	Ground; internally connected to heat sink
4	N.C.	Not connected
5	Q	<b>Output;</b> block to ground with a ceramic capacitor, $C \ge 470 \text{ nF}$



Table 2 Absolute Maximum Ratings

		•			
Parameter	Symbol	Lim	it Values	Unit	Test Condition
		Min.	Max.		
Input I		1	<u> </u>		
Voltage	$V_1$	-0.3	45	V	_
Current	$I_{I}$	-1	_	mA	_
Inhibit INH	·		·		
Voltage	$V_{\overline{INH}}$	-0.3	45	V	Observe current limit $I_{\overline{\text{INH}},\text{max}}^{1)}$
Current	$I_{\overline{INH}}$	-1	1	mA	_
Output Q					
Voltage	$V_{Q}$	-0.3	5.5	V	_
Voltage	$V_{Q}$	-0.3	6.2	V	$t < 10 \text{ s}^{2)}$
Current	$I_{Q}$	-1	_	mA	_
Temperature	·		•		
Junction temperature	$T_{j}$	-40	150	°C	_
Storage temperature	$T_{stg}$	-50	150	°C	_
		+			

<sup>1)</sup> External resistor required to keep current below absolute maximum rating when voltages ≥ 5.5 V are applied.

Note: Stresses above those listed here may cause permanent damage to the device. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Table 3 Operating Range

Parameter	Symbol	Limit Values		Unit	Remarks
		Min.	Max.		
Input voltage	$V_1$	5.5	42	V	_
Junction temperature	$T_{i}$	-40	150	°C	_

<sup>2)</sup> Exposure to these absolute maximum ratings for extended periods (t > 10 s) may affect device reliability.



Table 4 Thermal Resistance

Parameter	Symbol	Limi	it Values	Unit	Remarks
		Min.	Max.		
Junction case	$R_{thj-c}$	_	8	K/W	_
Junction ambient	$R_{thj-a}$	_	80	K/W	TO252 <sup>1)</sup>
Junction ambient	$R_{thj-a}$	_	55	K/W	TO263 <sup>2)</sup>

<sup>1)</sup> Worst case, regarding peak temperature; zero airflow; mounted on a PCB FR4,  $80 \times 80 \times 1.5 \text{ mm}^3$ , heat sink area 300 mm<sup>2</sup>

Note: In the operating range, the functions given in the circuit description are fulfilled.

<sup>2)</sup> Worst case, regarding peak temperature; zero airflow; mounted on a PCB FR4,  $80 \times 80 \times 1.5$  mm³, heat sink area 300 mm²



Table 5 Electrical Characteristics

 $V_{\rm I}$  = 13.5 V;  $V_{\overline{\rm INH}}$  = 5 V; -40 °C <  $T_{\rm I}$  < 150 °C (unless otherwise specified)

Parameter	Symbol	Limit Values			Unit	<b>Measuring Condition</b>
		Min.	Тур.	Max.		
Output Q		1	1	1		1
Output voltage	$V_{Q}$	4.9	5.0	5.1	V	0.1 mA < $I_{\rm Q}$ < 300 mA; 6 V < $V_{\rm I}$ < 16 V
Output voltage	$V_{Q}$	4.9	5.0	5.1	V	0.1 mA < $I_{\rm Q}$ < 100 mA; 6 V < $V_{\rm I}$ < 40 V
Output current limitation	$I_{Q}$	320	_	_	mA	1)
Output current limitation	$I_{Q}$	_	_	800	mA	$V_{\rm Q}$ = 0V
Current consumption; $I_q = I_l - I_Q$	$I_{q}$	_	20	30	μΑ	$I_{\rm Q}$ = 0.1 mA; $T_{\rm j}$ = 25 °C
Current consumption; $I_{q} = I_{l} - I_{Q}$	$I_{q}$	_	_	40	μА	$I_{\rm Q}$ = 0.1 mA; $T_{\rm j} \le$ 80 °C
Quiescent current; inhibited	$I_{q}$	_	5	9	μА	$V_{\overline{\text{INH}}} = 0 \text{ V};$ $T_{\text{j}} < 80 \text{ °C}$
Drop voltage	$V_{dr}$	_	250	500	mV	$I_{\rm Q}$ = 200 mA; $V_{\rm dr}$ = $V_{\rm I}$ - $V_{\rm Q}^{(1)}$
Load regulation	$\Delta V_{Q, lo}$	-40	15	40	mV	$I_{\rm Q}$ = 5 mA to 250 mA
Line regulation	$\Delta V_{ m Q,  li}$	-20	5	20	mV	$V_{\rm I}$ = 10V to 32 V; $I_{\rm Q}$ = 5 mA
Power supply ripple rejection	PSRR	_	60	_	dB	$f_{\rm r}$ = 100 Hz; $V_{\rm r}$ = 0.5 Vpp
Temperature output voltage drift	$\mathrm{d}V_{\mathrm{Q}}/\mathrm{d}T$	_	0.5	_	mV/K	_
Output Capacitor	$C_{Q}$	470	_	_	nF	ESR < 3 Ohm
Inhibit Input INH						1
Turn-on Voltage	$V_{\overline{INH}ON}$	3.1	_	_	V	V <sub>Q</sub> ≥4.9 V
Turn-off Voltage	$V_{\overline{\text{INH OFF}}}$	_	_	8.0	V	V <sub>Q</sub> ≤0.3 V
H-input current	$I_{\overline{INH}ON}$	-	3	4	μА	V <sub>INH</sub> = 5 V
L-input current	$I_{\overline{INH}OFF}$	-	0.5	1	μА	$V_{\overline{\text{INH}}} = 0 \text{ V};$ $T_{\text{j}} < 80 \text{ °C}$

<sup>1)</sup> Measured when the output voltage  $V_Q$  has dropped 100 mV from the nominal value obtained at  $V_1$  = 13.5 V.



#### **Application Information**

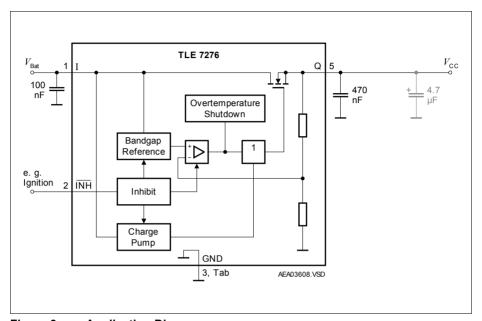


Figure 3 Application Diagram

#### Input, Output

An input capacitor is necessary for damping line influences. A resistor of approx. 1  $\Omega$  in series with  $C_1$ , can damp the LC of the input inductivity and the input capacitor.

In contrast to most low drop voltage regulators the TLE 7276 only needs moderate capacitance at the output to assure stability of the regulation loop. This offers more design flexibility to the circuit designer providing for cost efficient solutions.

The TLE 7276 requires a ceramic output capacitor of at least 470 nF. In order to damp influences resulting from load current surges it is recommended to add an additional electrolytic capacitor of 4.7  $\mu$ F to 47  $\mu$ F at the output as shown in **Figure 3**.



Additionally a buffer capacitor  $C_B$  of >  $10\mu F$  should be used for the output to suppress influences from load surges to the voltage levels. This one can either be an aluminum electrolytic capacitor or a tantalum capacitor following the application requirements.

A general recommendation is to keep the drop over the equivalent serial resistor (ESR) together with the discharge of the blocking capacitor below the allowed Headroom of the Application to be supplied (e.g. typ.  $dV_{\Omega} = 350 \text{mV}$ ).

Since the regulator output current roughly rises linearly with time the discharge of the capacitor can be calculated as follows:

$$dVC_B = dI_Q*dt/C_B$$

The drop across the ESR calculates as:

$$dV_{ESR} = dI*ESR$$

To prevent a reset the following relationship must be fullfilled:

$$dV_C + dV_{ESR} < V_{RH} = 350 \text{mV}$$

Example: Assuming a load current change of  $dI_Q$  = 100mA, a blocking capacitor of  $C_B$  = 22µF and a typical regulator reaction time under normal operating conditions of dt ~ 25µs and for special dynamic load conditions, such as load step from very low base load, a reaction time of dt ~ 75µs.

$$dV_C = dI_Q*dt/C_B = 100mA * 25\mu s/22\mu F = 113mV$$

So for the FSR we can allow

$$dV_{ESR} = V_{RH2} - dV_{C} = 350 \text{mV} - 113 \text{mV} = 236 \text{mV}$$

The permissible ESR becomes:

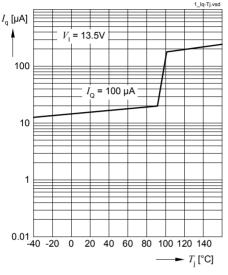
$$ESR = dV_{ESR} / dI_{Q} = 236 \text{mV} / 100 \text{mA} = 2.36 \text{Ohm}$$

During design-in of the TLE7469 product family, special care needs to be taken with regards to the regulators reaction time to sudden load current changes starting from very low pre-load as well as cyclic load changes. The application note "TLE7x Voltage Regulators - Application Note about Transient Response at ultra low quiescent current Voltage Regulators" (see 3\_cip05405.pdf) gives important hints for successful design-in of the Voltage Regulators of the TLE7x family.

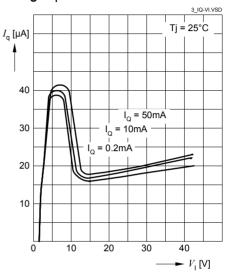


#### **Typical Performance Characteristics**

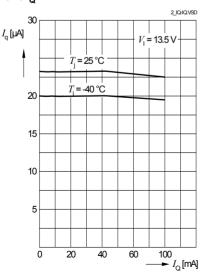
# Current Consumption $I_q$ versus Junction Temperature $T_i$



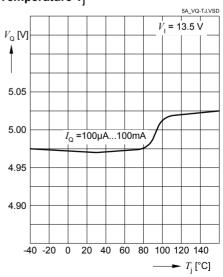
## Current Consumption $I_q$ versus Input Voltage $V_I$



# Current Consumption $I_q$ versus Output Current $I_Q$

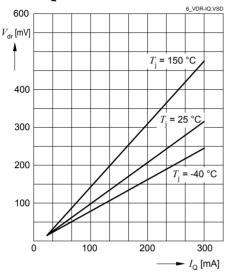


# Output Voltage $V_Q$ versus Junction Temperature $T_i$

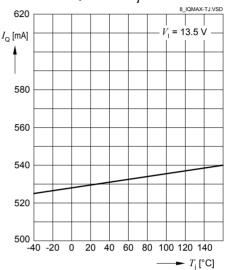




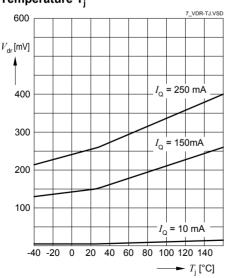
## Dropout Voltage $V_{dr}$ versus Output Current $I_{O}$



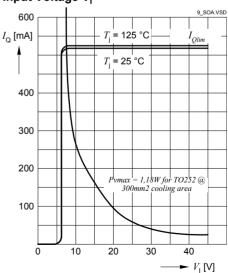
#### 



## Dropout Voltage $V_{dr}$ versus Junction Temperature $T_i$

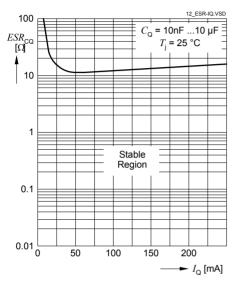


## Maximum Output Current $I_Q$ versus Input Voltage $V_I$

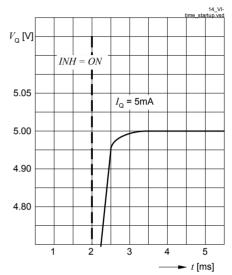




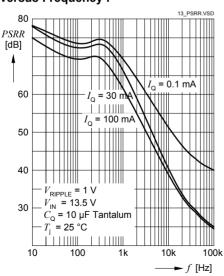
#### **Region of Stability**



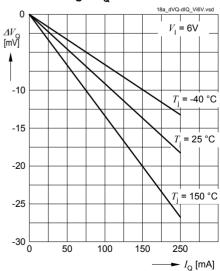
#### Output Voltage V<sub>Q</sub> Start-up behaviour



## Power Supply Ripple Rejection PSRR versus Frequency f

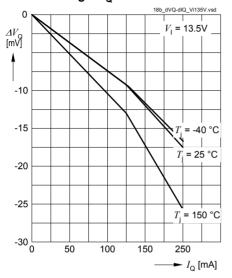


## Load Regulation $dV_Q$ versus Output Current Change $dI_Q$

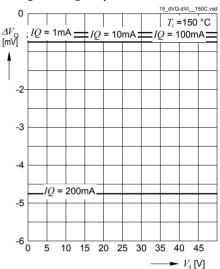




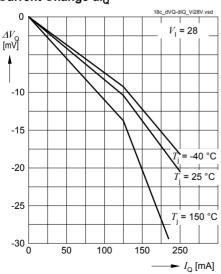
## Load Regulation dV<sub>Q</sub> versus Output Current Change dI<sub>Q</sub>



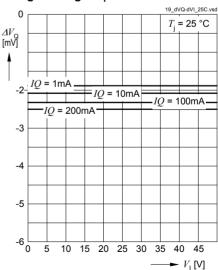
# Line Regulation $\mathrm{dV}_{\mathrm{Q}}$ versus Input Voltage Change $\mathrm{dV}_{\mathrm{I}}$



## Load Regulation $dV_Q$ versus Output Current Change $dI_Q$

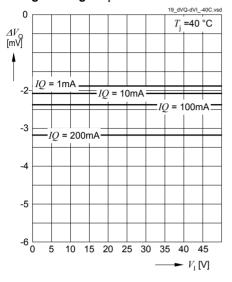


## Line Regulation dV<sub>Q</sub> versus Input Voltage ChangedV<sub>I</sub>

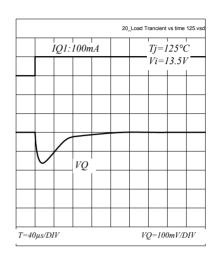




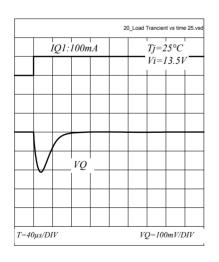
## Line Regulation dV<sub>Q</sub> versus Input Voltage ChangedV<sub>I</sub>



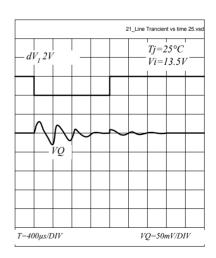
## Load Transient Response Peak Voltage $dV_O$



## Load Transient Response Peak Voltage $dV_{\Omega}$

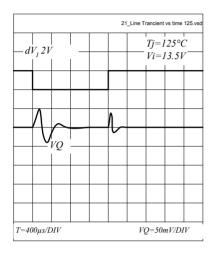


## Line Transient Response Peak Voltage $dV_{\Omega}$

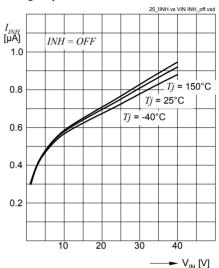




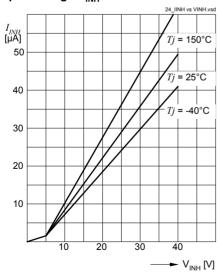
## Line Transient Response Peak Voltage $dV_O$



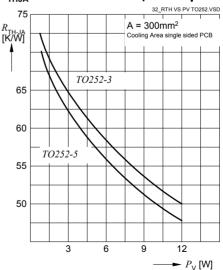
## Inhibit Input Current $I_{INH}$ versus Input Voltage $V_{I}$ , INH=Off



## Inhibit Input Current $I_{INH}$ versus Inhibit Input Voltage $V_{INH}$



## Thermal Resistance Junction-Ambient R<sub>THJA</sub> versus Power Dissipation P<sub>V</sub>





#### **Package Outlines**

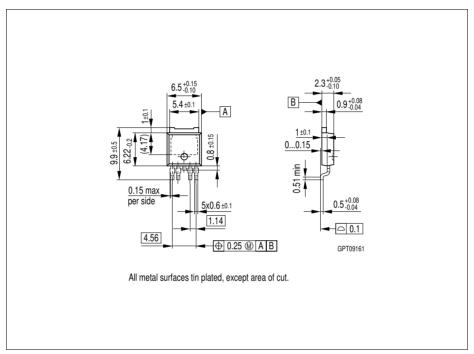


Figure 4 P-TO252-5-1 (Plastic Transistor Single Outline)



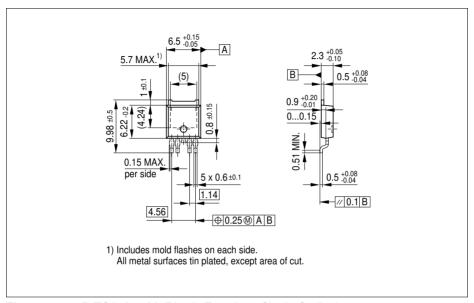


Figure 5 P-TO252-5-11 (Plastic Transistor Single Outline)

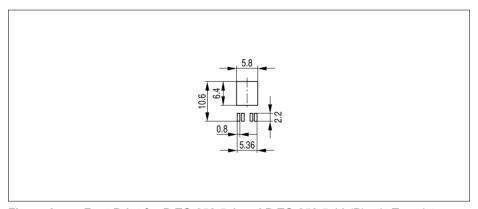


Figure 6 Foot Print for P-TO-252-5-1 and P-TO-252-5-11 (Plastic Transistor Single Outline)



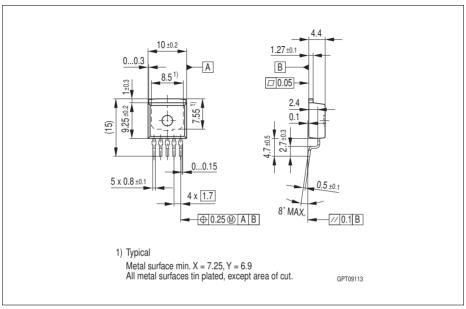


Figure 7 P-TO263-5-1 (Plastic Transistor Single Outline)

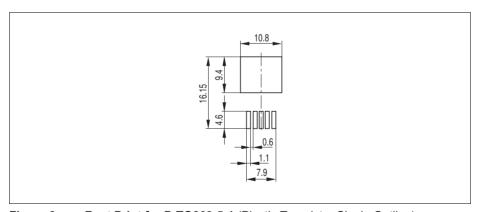


Figure 8 Foot Print for P-TO263-5-1 (Plastic Transistor Single Outline)

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Dimensions in mm



#### Remarks

TLE 727 5-V Low	6 D Drop Voltag	e Regulator					
Revision	n History:	2010-11-22	Rev. 1.11				
Previous	Version:	1.1					
Page	Subjects	Subjects (major changes since last revision)					
4	Pin config	Pin configuration: Typo corrected (No change of product, process or test)					
all	New Infin	New Infineon-Layout and Cover added					

Edition 2010-11-22
Published by
Infineon Technologies AG
81726 Munich, Germany
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